



Features:

- Plastic package
- · Exceeds environmental standards of MIL-STD-19500
- 600W surge capability at 10 × 1,000μs waveform, duty cycle: 0.01%
- Excellent clamping capability
- Low Zener impedance
- Fast response time: typically less than 1ps from 0V to VBR for unidirectional and 5ns for bidirectional
- Typical IR less than 1µA above 10V
- High temperature soldering guaranteed: 260°C/10 seconds/0.375" (9.5mm) lead length/5lbs. (2.3kg) tension

Mechanical Data:

Case : Moulded plastic

Lead : Axial leads, solderable per MIL-STD-202, Method 208

Polarity : Colour band denotes cathode except bipolar

Weight: 0.34g

Maximum Ratings and Electrical Characteristics ($T_A = 25$ °C)

Type Number	Symbol	Value	Units	
Peak Pulse Power Dissipation at T _A = 25°C, Tp = 1ms (Note)	P_PP	Min. 600		
Steady State Power Dissipation at T _L = 75°C Watts Lead Lengths 0.375" 9.5mm	P _D	1.7	W	
Peak Forward Surge Current, 8.3ms Single Half Sine-wave Superimposed on Rated Load (JEDEC method)	I _{FSM}	100	А	
Junction to Leads	R _{θJL}	60		
Junction to Ambient on Printed Circuit. L Lead = 10mm	$R_{\theta JA}$	100	°C/W	
Operating and Storage Temperature Range	T _J , T _{STG}	-65°C to +175°C	°C	

Note: For a surge greater than the maximum values, the diode will fall in short-circuit

Electrical Characteristics (T_A = 25°C unless otherwise noted)

I _{RM} at \	/ _{RM}		V _{BR} a	t I _R		V _{CL} at	l _{PP}	V _{c∟} at I	PP	αΤ	С	
Max.		Note1			Max.		Max.		Max.	Тур.		
		Min.	Nom.	Max.		10/1,000)µs	8/20µ\$	S	Note2	Note3	
μA	V	V	V	٧	mA	٧	Α	V	Α	10⁴/°C	(pF)	Bidirectional
1	10.2	114	120	126	1	165	3.6	212	19	10.7	450	BZW06-102B

Notes: 1. Pulse test: tp <50ms.

2. $\Delta V_{BR} = \alpha T \times (T_{amb} - 25) \times VBR (25^{\circ}C)$.

3. V_R = 0V, F = 1MHz, For bidirectional types, capacitance value is divided by 2.

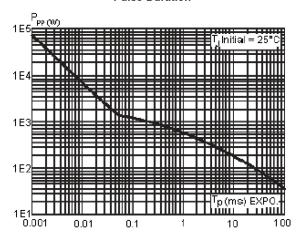
www.element14.com www.farnell.com www.newark.com



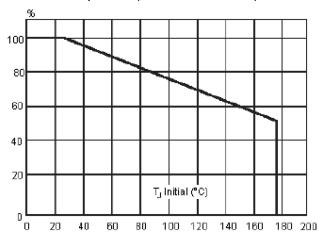


Ratings and Characteristic Curves

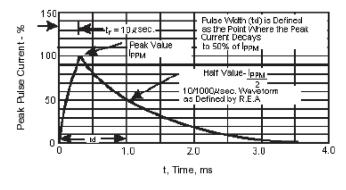
Peak Pulse Power Versus Exponential Pulse Duration



Peak Pulse Power Dissipation Versus Initial Junction Temperature (Printed Circuit Board)



Pulse Waveform



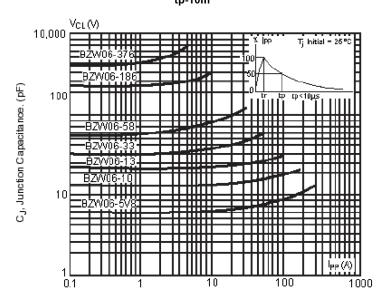




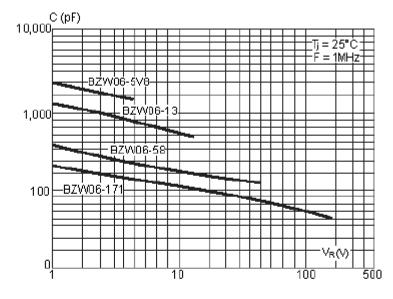


Ratings and Characteristic Curves

Clamping Voltage Versus Peak Pulse Current Exponential Waveform tp-200µs tp-1ms tp-10m



Characteristics Versus Reverse Applied Voltage for Unidirectional Types (Typical Values)

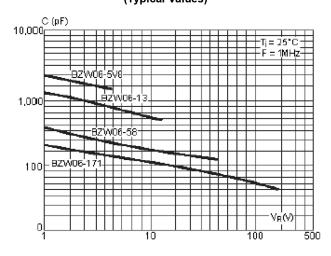




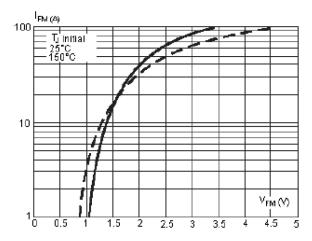


Ratings and Characteristic Curves

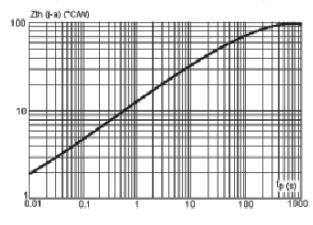
Characteristics Versus Reverse Applied Voltage for Unidirectional Types (Typical Values)



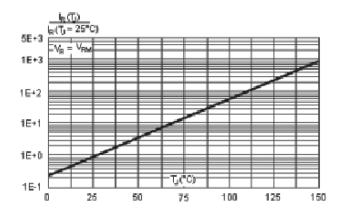
Peak Forward Voltage Drop Versus Peak Forward Current (Typical Values for Unidirectional Types)



Transient Thermal Impedance Junction Ambient Versus Pulse Duration (For FR4 PC Board With L Lead = 10mm)

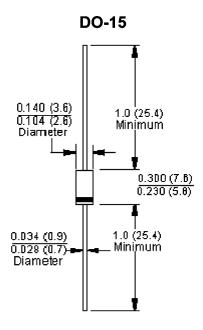


Relative Variation of Leakage Current Versus Junction Temperature









Dimensions: Inches (Millimetres)

Part Number Table

Description	Part Number
Diode, TVS, 120V, 600W	BZW06-102B

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